2SC3743

Silicon NPN triple diffusion planar type

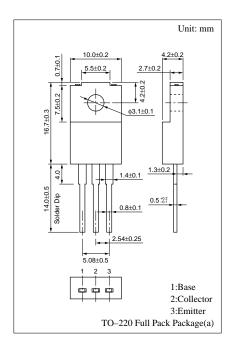
For high breakdown voltage high-speed switching

Features

- High-speed switching
- Wide area of safe operation (ASO) with high breakdown voltage
- Satisfactory linearity of foward current transfer ratio h_{FE}
- Full-pack package which can be installed to the heat sink with one screw

Absolute Maximum Ratings (T_C=25°C)

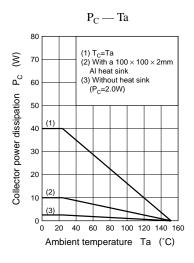
Parameter	Symbol	Ratings	Unit	
Collector to base voltage	V _{CBO}	900	V	
C-11	V _{CES}	900	V	
Collector to emitter voltage	V _{CEO}	800	V	
Emitter to base voltage	V _{EBO}	7	V	
Peak collector current	I _{CP}	5	A	
Collector current	I_C	3	A	
Base current	I_{B}	1	A	
Collector power T _C =25°C	, n	40	***	
dissipation Ta=25°C	P _C	2	W	
Junction temperature	Tj	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	

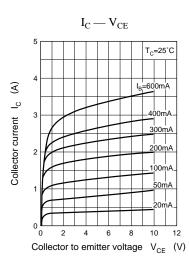


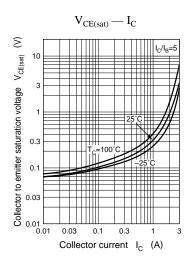
Electrical Characteristics (T_C=25°C)

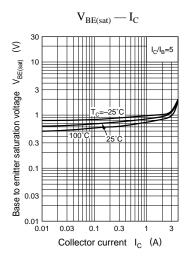
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I _{CBO}	$V_{CB} = 900V, I_E = 0$			50	μА
Emitter cutoff current	I _{EBO}	$V_{EB} = 7V, I_{C} = 0$			50	μА
Collector to emitter voltage	V _{CEO}	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$	800			V
Forward current transfer ratio	h _{FE1}	$V_{CE} = 5V, I_{C} = 0.1A$	6			
	h _{FE2}	$V_{CE} = 5V, I_{C} = 0.8A$	6			
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = 0.8A, I_B = 0.16A$			0.6	V
Base to emitter saturation voltage	V _{BE(sat)}	$I_C = 0.8A, I_B = 0.16A$			1.2	V
Transition frequency	f_T	$V_{CE} = 5V, I_{C} = 0.1A, f = 1MHz$		4		MHz
Turn-on time	t _{on}	I 004 I 0164 I 0224			1.0	μs
Storage time	t _{stg}	$I_C = 0.8A, I_{B1} = 0.16A, I_{B2} = -0.32A,$			4.0	μs
Fall time	t _f	$V_{CC} = 250V$			1.0	μs

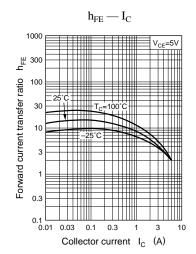
Power Transistors 2SC3743

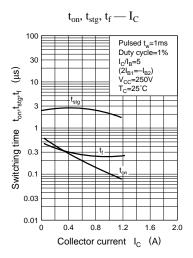




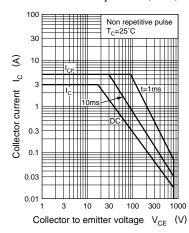








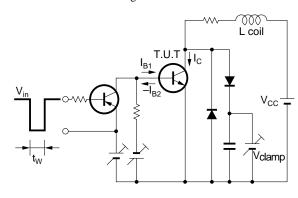
Area of safe operation (ASO)



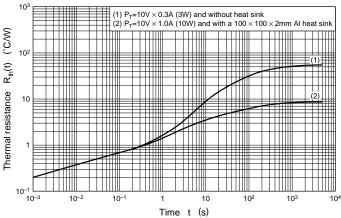
Power Transistors 2SC3743

Area of safe operation, reverse bias ASO

Reverse bias ASO measuring circuit







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